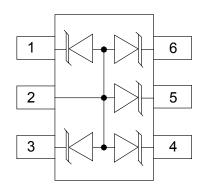


5-Lines Unidirectional Ultra-low Capacitance Transient Voltage Suppressors

Descriptions

The ESD5M800TR is an ultra-low capacitance TVS (Transient Voltage Suppressor) array designed to protect high speed data interfaces. It has been specifically designed to protect sensitive electronic components which are connected to data and transmission lines from over-stress caused by ESD (Electrostatic Discharge).

The low capacitance array configuration allows the user to protect four high-speed data or transmission lines. The low inductance construction minimizes voltage overshoot during high current surges. This device is optimized for ESD protection of portable electronics. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±20kV air, ±15kV contact discharge).



SC-70 6L(Top View)

5

6



- Transient protection for high-speed data lines to IEC 61000-4-2 (ESD) ±20kV (air), ±15kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns)
- Array of surge rated diodes with internal TVS Diode
- Protects up to four I/O lines & power line
- Low leakage current and clamping voltage
- Low operating voltage: 5.0V
- Solid-state silicon-avalanche technology

Applications

- Cellular Handsets and Accessories
- Cordless Phones
- Personal Digital Assistants (PDA's)
- Notebooks and Handhelds
- Portable Instrumentation
- Digital Cameras
- Peripherals
- MP3 Players

Order information

Device	Package	Mark	Shipping	
ESD5M800TR	SC-70 6L	5C	3000/Tape&Reel	

2



Absolute maximum ratings

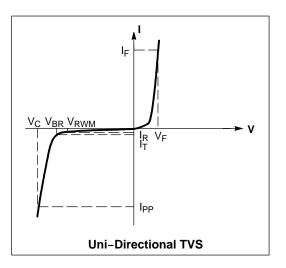
Parameter	Symbol	Rating	Unit	
Peak pulse power (t _p = 8/20µs)	P _{pk}	120	W	
Peak pulse current ($t_p = 8/20\mu s$)	I _{PP}	10	А	
ESD according to IEC61000-4-2 air discharge	V	±20	kV	
ESD according to IEC61000-4-2 contact discharge	V _{ESD}	±15	KV	
Operation junction temperature	TJ	-55~150	°C	
Lead temperature	TL	260	°C	
Storage temperature	T _{STG}	-55~150	°C	

Electrical characteristics (TA=25 oC, unless otherwise noted)

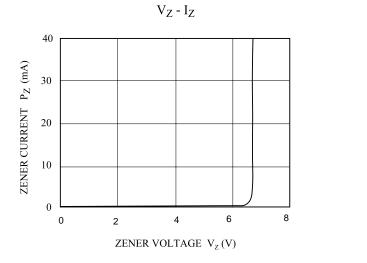
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Reverse stand-off voltage	V _{RWM}				5.0	V
Reverse leakage current	I _R	$V_{RWM} = 5.0V$			1.0	uA
Reveres breakdown voltage	V _{BR12}	I _T =1mA	6.0		8.0	V
Clamping voltage	Vc	Ipp=1A tp=8/20us			9.0	V
		Ipp=10A tp=8/20us			12.5	V
Junction capacitance	CJ	$V_R = 0V$, f = 1MHz		80.0	120.0	pF

Electrical performance curve

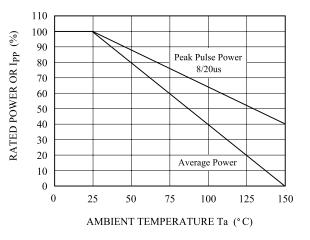
Symbol	Parameter		
V _{RWM}	Peak Reverse Working Voltage		
I _R	Reverse Leakage Current @ V_{RWM}		
V _{BR}	Breakdown Voltage @ I_T		
Ι _Τ	Test Current		
I _{PP}	Maximum Reverse Peak Pulse Current		
Vc	Clamping Voltage @ IPP		
١ _F	Forward Current		
VF	Forward Voltage @ I _F		



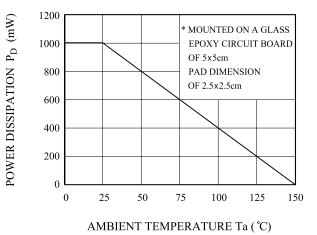
ASM



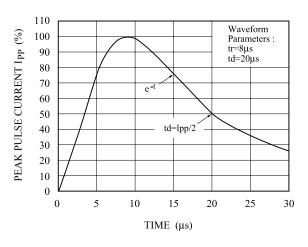
POWER DERATION CURVE



P_D - Ta



PULSE WAVEFORM



REV1.1

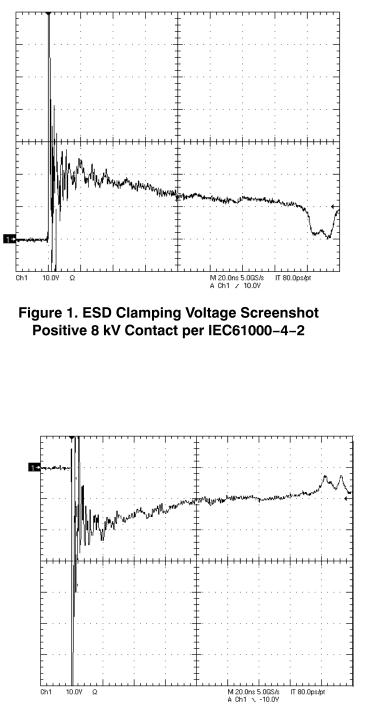


Figure 2. ESD Clamping Voltage Screenshot Negative 8 kV Contact per IEC61000-4-2

Applications Information

Device Connection Options for Protection of Four High-Speed Data Lines

This device is designed to protect data lines by clamping them to a fixed reference. When the voltage on the protected line exceeds the reference voltage the steering diodes are forward biased, conducting the transient current away from the sensitive circuitry. Data lines are connected at pins 1, 3, 4 and 6. Pin 2 should be connected directly to a ground plane. The path length is kept as short as possible to minimize parasitic inductance.

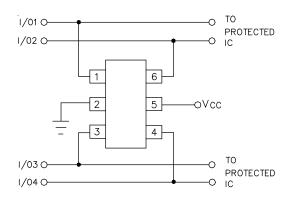
The positive reference is connected at pin 5. The options for connecting the positive reference are as follows:

- 1. To protect data lines and the power line, connect pin 5 directly to the positive supply rail (V_{cc}). In this configuration the data lines are referenced to the supply voltage. The internal TVS diode prevents over-voltage on the supply rail.
- In applications where the supply rail does not exit the system, the internal TVS may be used as the reference. In this case, pin 5 is not connected. The steering diodes will begin to conduct when the voltage on the protected line exceeds the working voltage of the TVS (plus one diode drop).
- 3. In applications where complete supply isolation is desired, the internal TVS is again used as the reference and V_{cc} is connected to one of the I/O inputs. An example of this configuration is the protection of a SIM port. The Clock, Reset, I/O, and VCC lines are connected at pins 1, 3, 4, and 6. Pin 2 is connected to ground and pin 5 is not connected.

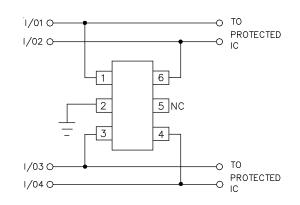
Matte Tin Lead Finish

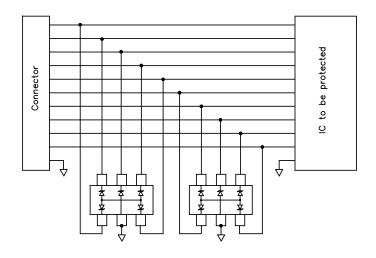
Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

Protection of Four Data Lines and Power Supply Line



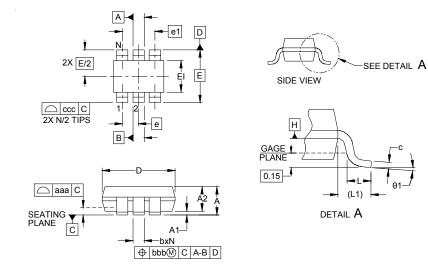
Protection of Four Data Lines Using Internal TVS Diode as Reference







Outline Drawing SC70-6L

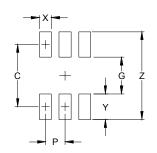


DIMENSIONS						
DIM INCHES			MILLIMETERS			
	MIN	NOM	MAX	MIN	NOM	MAX
Α	-	-	.043	-	-	1.10
A1	.000	-	.004	0.00	-	0.10
A2	.028	.035	.039	0.70	0.90	1.00
b	.006	-	.012	0.15	-	0.30
С	.003	-	.009	0.08	-	0.22
D	.075	.079	.083	1.90	2.00	2.10
E1	.045	.049	.053	1.15	1.25	1.35
Е	.083 BSC			2.10 BSC		
е	.026 BSC			0.65 BSC		
e1		.051		1.30 BSC		
L	.010	.014	.018	0.26	0.36	0.46
L1	(.017)			(0.42)		
N	6			6		
θ1	0°	-	8°	0°	-	8°
aaa	.004			0.10		
bbb	.004			0.10		
CCC	.012				0.30	

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. DATUMS -A- AND -B- TO BE DETERMINED AT DATUM PLANE-H-
- 3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 4. REFERENCE JEDEC STD MO-203, VARIATION AB.

Land Pattern SC70-6L



DIMENSIONS			
DIM	INCHES	MILLIMETERS	
С	(.073)	(1.85)	
G	.039	1.00	
Р	.026	0.65	
Х	.016	0.40	
Y	.033	0.85	
Z	.106	2.70	

NOTES:

1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.